

Suggesting changes to the current Lacewing prototype

Temperature-Sensing



- Not ideal to place a temperature sensor on the reader PCB
- Place thermistor on the cartridge for temperature reading

Wi-Fi and Bluetooth



- Improved connection from Bluetooth 2.0 to Bluetooth BLE with greater flexibility in data transmission
- More possibilities for the usability of the product

GPS and 3G



- Ideal for use in lower-income countries
- GPS to track regions where epidemics may be occurring

Microcontroller



- The STM32 is out of stock [2] due to global chip shortage so must choose a new, in stock, MCU
- Considerations for new MCU: stock, price, RAM, Flash memory and communication interfaces

need for new functionalities

Microcontroller



Combined Wi-Fi and Bluetooth



- ESP32-S3 Wi-Fi Development Kit was ordered
- Bluetooth 5.2 and Wi-Fi connection were tested and work

Temperature-Sensing circuit



- A thermistor was used in a wheatstone bridge circuit

Bluetooth



- BMD-330-EVAL development kit was tested
- Not chosen due to difficulty with user interface

3. Designing a PCB - a new PCB to integrate all new components

Altium - software for designing PCBs

- give access to pins that will help with development and debugging
- surrounding tracks will not affect each other
- power and the reduction of cross talk and electromagnetic interference
- 6. The PCB was sent for manufacture



support/documentation, but has been chosen for the final design as an extra MCU for robustness



• Resistors chosen for the largest rate of change of voltage around air temperature • Tested with several thermistors to ensure reliability between thermistors



• CYW43439 Wi-Fi Development Kit was tested • Not chosen as lacked of development resources

1. The PCB of the Lacewing 0.5 was inspected, and all replaced components were removed 2. The new circuit was designed to enable selection between two MCUs on board and to

3. The schematic and PCB floorplan was updated to include the new components 4. The tracks that connect each component were drawn, with care taken to make sure

5. The ground and power layers of the PCB were drawn, to ensure good distribution of



[2] https://www.mouser.co.uk/c/?marcom=148435903